



JIANGSU CHANGJING ELECTRONICS TECHNOLOGY CO., LTD

## TO-263K Plastic-Encapsulate Thyristors

### CT314Q 3Q TRIACs

#### MAIN CHARACTERISTICS

$I_{T(RMS)}$		14A
$V_{DRM}/V_{RRM}$	CT314Q-600S/C/B	600V
	CT314Q-800S/C/B	800V
$V_{TM}$		1.55V

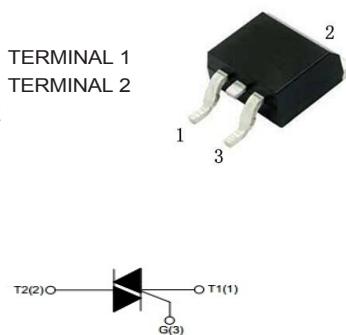
#### FEATURES

- NPNPN 5-layer Structure TRIACs
- Mesa Glass Passivated Technology
- Multi Layers Metal Electrodes
- High Junction Temperature
- Good Commutation Performance
- High dV/dt and dl/dt

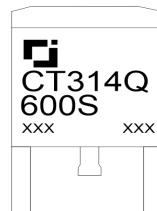
#### APPLICATIONS

- Heater Control
- Motor Speed Controller
- Mixer

#### TO-263K



#### MARKING



CT314Q:Series Code  
600S:Depends on  $V_{DRM}$  and IGT  
XXX:Internal Code

#### ABSOLUTE RATINGS ( $T_a=25^\circ\text{C}$ unless otherwise noted )

Symbol	Parameter	Test condition		Value		Unit	
$V_{DRM}/ V_{RRM}$	Repetitive peak off-state voltage	$T_j=25^\circ\text{C}$	CT314Q-600S/C/B	600		V	
			CT314Q-800S/C/B	800		V	
$I_{T(RMS)}$	RMS on-state current	TO-263K( $T_c \leq 105^\circ\text{C}$ ), Fig. 1,2		14		A	
$I_{TSM}$	Non repetitive surge peak on-state current	Full sine wave , $T_j(\text{init})=25^\circ\text{C}$ , tp=20ms; Fig. 3,5		140		A	
$I^2t$	$I^2t$ value	tp=10ms		98		$\text{A}^2\text{s}$	
$dl/dt$	Critical rate of rise of on-state current	$I_G=2*I_{GT}$ , $tr \leq 10\text{ns}$ , $F=120\text{Hz}$ , $T_j=125^\circ\text{C}$	I - II - III	50	$\text{A}/\mu\text{s}$		
			IV	n/a			
$I_{GM}$	Peak gate current	tp=20 $\mu\text{s}$ , $T_j=125^\circ\text{C}$		4		A	
$P_{G(AV)}$	Average gate power	$T_j=125^\circ\text{C}$		1		W	
$T_{STG}$	Storage temperature			-40~+150		$^\circ\text{C}$	
$T_j$	Operating junction temperature			-40~+125			

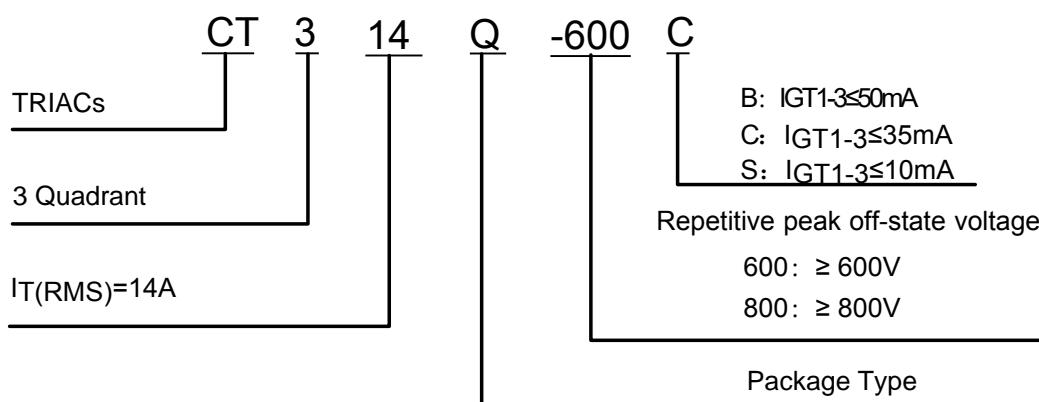
## ELECTRICAL CHARACTERISTICS ( $T_a=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter	Test condition	Value			Unit
			S	C	B	
$I_{GT}$	Gate trigger current	$V_D=12\text{V}$ , $R_L=30\Omega$ , $T_j=25^\circ\text{C}$ , Fig. 6	$\leq 10$ IV	$\leq 35$ n/a	$\leq 50$ n/a	mA
$V_{GT}$	Gate trigger voltage		I - II - III	$\leq 1.3$		
$V_{GD}$	Non-triggering gate voltage	$V_D=V_{DRM}$ , $R_L = 3.3\text{k}\Omega$ , $T_j=125^\circ\text{C}$	$\geq 0.2$			V
$I_H$	Holding current	$I_T=500\text{mA}$ , Fig. 6	$\leq 15$	$\leq 35$	$\leq 50$	mA
$I_L$	Latching current	$I_G=1.2I_{GT}$ , Fig. 6	$\leq 25$ II	$\leq 50$ $\leq 60$	$\leq 70$ $\leq 80$	mA
$dV_D/dt$	Critical rate of rise of off-state	$V_D=67\%V_{DRM}$ , Gate Open $T_j=125^\circ\text{C}$	$\geq 40$	$\geq 500$	$\geq 1000$	V/ $\mu\text{s}$
$V_{TM}$	On-state Voltage	$I_{TM}=17\text{A}$ , $t_p=380\mu\text{s}$ , Fig. 4	$\leq 1.55$			V
$I_{DRM} / I_{RRM}$	Repetitive peak off-state current	$V_D=V_{DRM}/V_{RRM}$ , $T_j=25^\circ\text{C}$	$\leq 5$	$\leq 5$	$\leq 5$	$\mu\text{A}$
		$V_D=V_{DRM}/V_{RRM}$ , $T_j=125^\circ\text{C}$	$\leq 1$	$\leq 1$	$\leq 1$	mA

## THERMAL RESISTANCES

Symbol	Parameter	Value	Unit
$R_{th} (j-c)$	Junction to case (AC)	1.3	$^\circ\text{C/W}$
$R_{th} (j-a)$	Junction to ambient	45	$^\circ\text{C/W}$

## PART NUMBER



## CHARACTERISTICS CURVES

FIG.1: Maximum power dissipation versus RMS on-state current (full cycle)

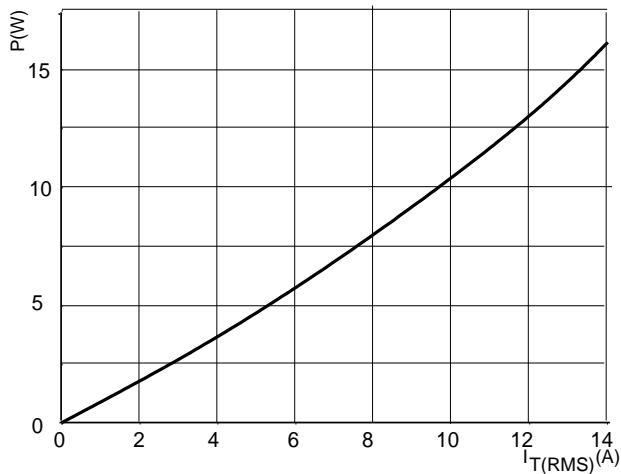


FIG.2: RMS on-state current versus case temperature (full cycle)

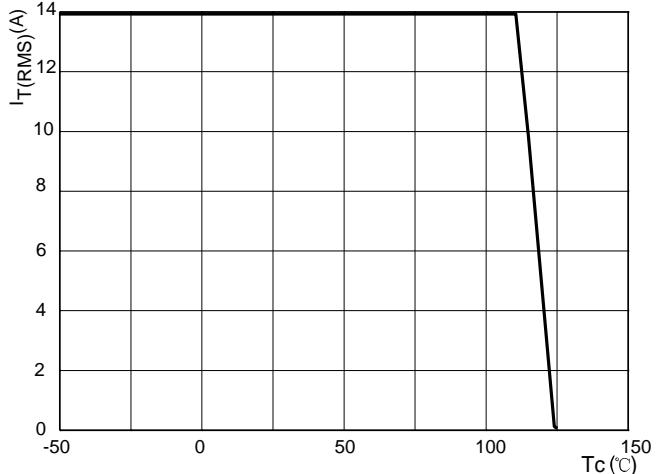


FIG.3: Surge peak on-state current versus number of cycles

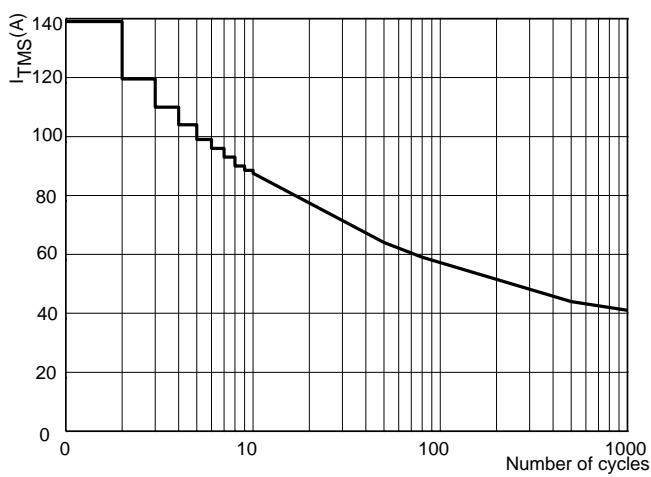


FIG.4: On-state characteristics (maximum values)

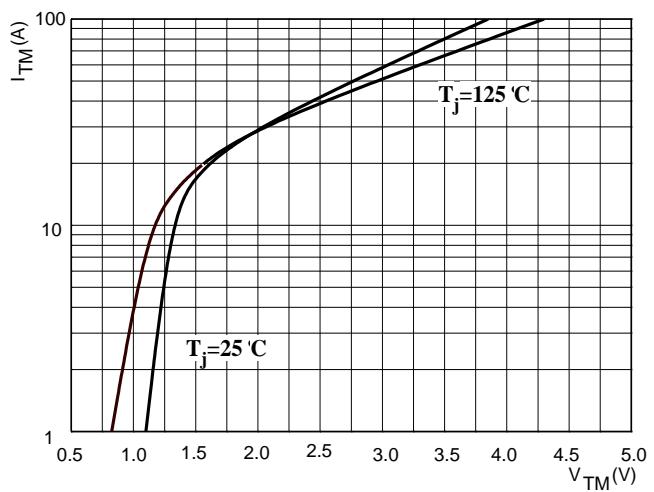


FIG.5: Non-repetitive surge peak on-state current for a sinusoidal pulse with width  $t_p < 10\text{ms}$

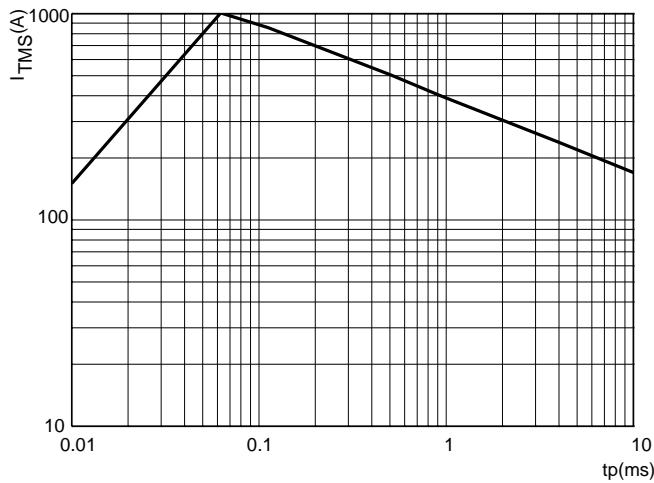
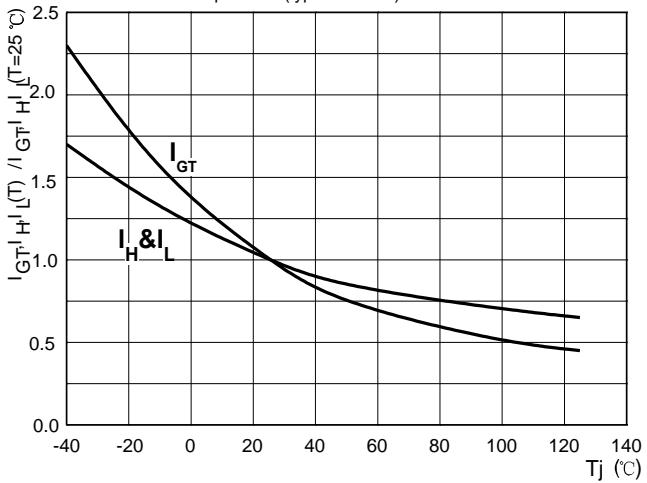
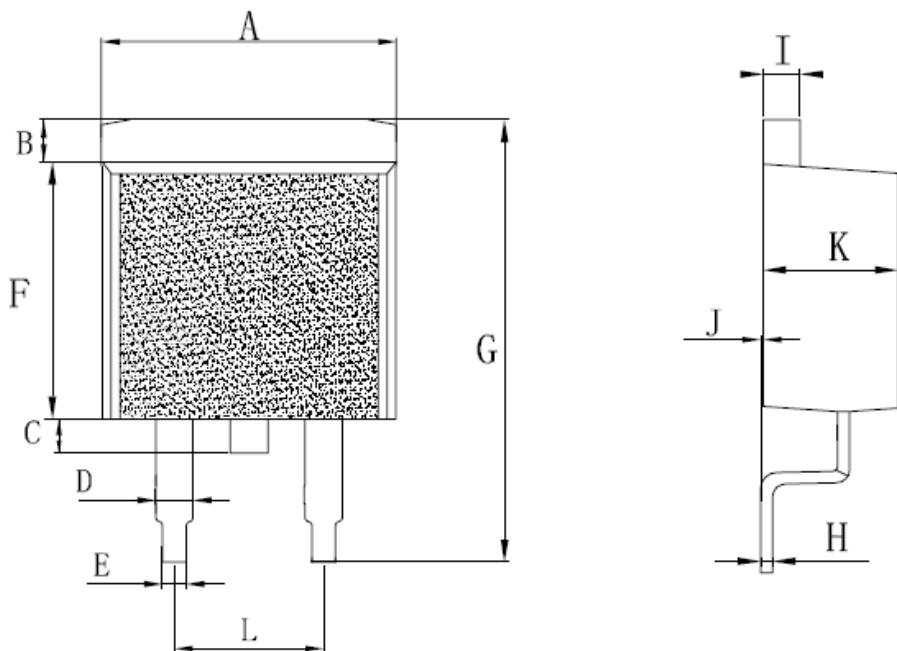


FIG.6: Relative variations of gate trigger current, holding current and latching current versus junction temperature (typical values)



## TO-263K PACKAGE OUTLINE DIMENSIONS



DIM.	Unit(mm)		Unit(inch)	
	Min	Max	Min	Max
A	9.7	10.4	0.381	0.409
B	1.31	1.62	0.051	0.063
C	0.65	1.22	0.025	0.048
D	1.15	1.36	0.045	0.053
E	0.62	0.95	0.024	0.037
F	8.75	9.32	0.344	0.366
G	14.75	15.8	0.580	0.622
H	0.32	0.48	0.012	0.018
I	1.18	1.36	0.046	0.053
J	0	0.15	0	0.005
K	4.38	4.86	0.172	0.191
L	4.85	5.23	0.190	0.205